

## **Features**

- Compliant with AEC-Q200 Rev-D- Stress Test Qualification for Passive Components in Automotive Applications
- Radial leaded devices
- Smaller size vs. comparable I<sub>hold</sub> ratings
- Faster tripping
- RoHS compliant\* and halogen free\*\*
- Agency recognition: c 🗫 us

## **Applications**

- Automotive applications
- Where space is limited and fast tripping is required

# MF-RG Series - PTC Resettable Fuses

## **Environmental Characteristics**

Item	Condition	Criteria
Operating Temperature	-40 °C to +85 °C	
Recommended Storage	+40 °C max. / 70 % R.H. max.	
Passive Aging	+85 °C, 1000 hours	±5 % typical resistance change
Humidity Aging	+85 °C, 85 % R.H. 1000 hours	±5 % typical resistance change
Thermal Shock	-40 °C to +85 °C, 10 times	±10 % typical resistance change
Solvent Resistance	MIL-STD-202, Method 215	No change (marking still legible)
Vibration	MIL-STD-883C, Method 2007.1 Condition A	No change (R <sub>min</sub> < R < R <sub>1max</sub> )
Moisture Sensitivity Level (MSL)	See Note	
ESD Classification	Class 6 (per AEC-Q200-2, HBM)	

## **Additional Information**

Click these links for more information:











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## **Electrical Characteristics**

	V <sub>max</sub> I <sub>max</sub>		Vmay	Imax	l <sub>hold</sub>	I <sub>trip</sub>		tial stance	1 Hour (R <sub>1</sub> ) Post-Trip Resistance	-	. Time Trip	Tripped Power Dissipation	Agency Recognition	AEC-Q200
Model	IIIax	IIIax	at 23 °C		at 23 °C Ohms		at 23 °C Ohms	at 23 °C		at 23 °C at 23 °C Watts		Compliant		
	Volts	Amps	An	nps	Min.	Max.	Max.	Amps	Seconds	Тур.	E174545			
MF-RG300	16	100	3.0	5.1	0.0380	0.0650	0.0975	15	1.0	2.3	✓	✓		
MF-RG400	16	100	4.0	6.8	0.0210	0.0385	0.0600	20	1.7	2.4	✓	✓		
MF-RG500	16	100	5.0	8.5	0.0150	0.0230	0.0340	25	2.0	2.6	✓	✓		
MF-RG600	16	100	6.0	10.2	0.0100	0.0185	0.0280	30	3.3	2.8	✓	✓		
MF-RG650	16	100	6.5	11.1	0.0088	0.0158	0.0240	33	3.5	3.0	✓	✓		
MF-RG700	16	100	7.0	11.9	0.0077	0.0130	0.0200	35	3.5	3.0	✓	1		
MF-RG800	16	100	8.0	13.6	0.0056	0.0110	0.0175	40	5.0	3.0	✓	1		
MF-RG900	16	100	9.0	15.3	0.0047	0.0092	0.0135	45	5.5	3.3	✓	1		
MF-RG1000	16	100	10.0	17.0	0.0040	0.0071	0.0102	50	6.0	3.6	✓	1		
MF-RG1100	16	100	11.0	18.7	0.0037	0.0062	0.0089	55	7.0	3.7	✓	/		

<sup>\*\*</sup> Bourns considers a product to be "halogen free" if (a) the Bromine (Br) content is 900 ppm or less; (b) the Chlorine (Cl) content is 900 ppm or less; and (c) the total Bromine (Br) and Chlorine (Cl) content is 1500 ppm or less. Specifications are subject to change without notice. Users should verify actual device performance in their specific applications. The products described herein and this document are subject to specific legal disclaimers as set forth on the last page of this document, and at <a href="https://www.bourns.com/docs/legal/disclaimer.pdf">www.bourns.com/docs/legal/disclaimer.pdf</a>.



<sup>\*</sup> RoHS Directive 2015/863, Mar 31, 2015 and Annex.

# **MF-RG Series - PTC Resettable Fuses**

## BOURNS®

## **Test Procedures and Requirements**

Item	Test Condition	Accept/Reject Criteria
Visual/Mechanical	Verify dimensions and materials	Per MF physical description
Resistance	In still air @ 23 °C	$R_{min} \le R \le R_{max}$
Time to Trip	5 times I <sub>hold</sub> , V <sub>max</sub> , 23 °C	T ≤ max. time to trip (seconds)
Hold Current	30 min. at I <sub>hold</sub>	No trip
Trip Cycle Life	V <sub>max</sub> , I <sub>max</sub> , 100 cycles	No arcing or burning
Trip Endurance	V <sub>max</sub> , 48 hours	No arcing or burning
Solderability	245 °C ±5 °C, 5 seconds	95 % min. coverage

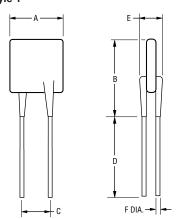
## **Product Dimensions**

Model	A Max.	<b>B</b> Max.	(		<b>D</b> Min.	E Max.	F Nom.		hysical acteristics
	IVIAX.	IVIAX.	Nom.	Tol. ±	IVIIII.	IVIAX.	INOITI.	Style	Wire Material
MF-RG300	7.1 (0.280)	11.0 (0.433)	<u>5.1</u> (0.201)	0.7 (0.028)	7.6 (0.299)	3.0 (0.118)	0.81 (0.032)	1	Sn/Cu
MF-RG400	9.9 (0.390)	12.8 (0.504)	5.1 (0.201)	0.7 (0.028)	7.6 (0.299)	3.0 (0.118)	<u>0.81</u> (0.032)	1	Sn/Cu
MF-RG500	10.4 (0.409)	14.3 (0.563)	5.1 (0.201)	0.7 (0.028)	7.6 (0.299)	3.0 (0.118)	0.81 (0.032)	1	Sn/Cu
MF-RG600	10.7 (0.421)	<u>17.1</u> (0.673)	<u>5.1</u> (0.201)	0.7 (0.028)	7.6 (0.299)	3.0 (0.118)	<u>0.81</u> (0.032)	1	Sn/Cu
MF-RG650	11.2 (0.441)	19.7 (0.776)	<u>5.1</u> (0.201)	<u>0.7</u> (0.028)	7.6 (0.299)	3.0 (0.118)	<u>0.81</u> (0.032)	1	Sn/Cu
MF-RG700	11.2 (0.441)	19.7 (0.776)	<u>5.1</u> (0.201)	0.7 (0.028)	7.6 (0.299)	3.0 (0.118)	0.81 (0.032)	1	Sn/Cu
MF-RG800	12.7 (0.500)	20.9 (0.823)	<u>5.1</u> (0.201)	0.7 (0.028)	7.6 (0.299)	3.0 (0.118)	<u>0.81</u> (0.032)	1	Sn/Cu
MF-RG900	14.0 (0.551)	21.7 (0.854)	<u>5.1</u> (0.201)	0.7 (0.028)	7.6 (0.299)	3.0 (0.118)	<u>0.81</u> (0.032)	1	Sn/Cu
MF-RG1000	16.5 (0.650)	25.2 (0.992)	<u>5.1</u> (0.201)	0.7 (0.028)	7.6 (0.299)	3.0 (0.118)	0.81 (0.032)	1	Sn/Cu
MF-RG1100	17.5 (0.689)	<u>26.0</u> (1.024)	<u>5.1</u> (0.201)	0.7 (0.028)	7.6 (0.299)	3.0 (0.118)	0.81 (0.032)	1	Sn/Cu

DIMENSIONS: (IN)

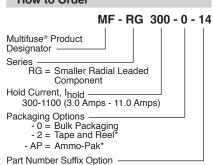
MM (INCHES)

## Style 1



Also available with kinked leads (see How to Order).

## **How to Order**

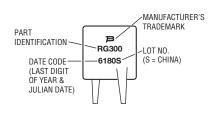


- \_\_ = Standard Straight Leads without part number suffix option
- 14 = Kinked Leads where straight leads are standard

\*Packaged per EIA-468

## Typical Part Marking

Represents total content. Layout may vary.



Specifications are subject to change without notice. Users should verify actual device performance in their specific applications.

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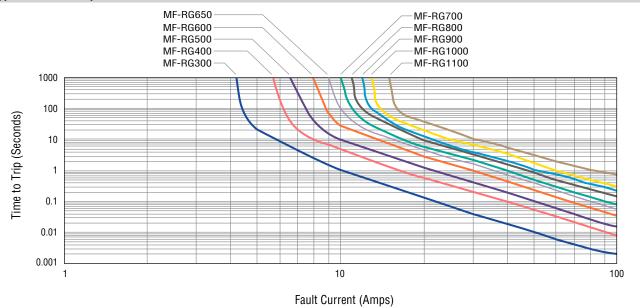
 $\underline{www.bourns.com/docs/legal/disclaimer.pdf}.$ 

## Thermal Derating Table - Ihold (Amps)

Model	Ambient Operating Temperature											
	-40 °C	-20 °C	0 °C	23 °C	40 °C	50 °C	60 °C	70 °C	85 °C			
MF-RG300	4.4	4.0	3.6	3.0	2.6	2.4	2.1	1.9	1.4			
MF-RG400	5.9	5.3	4.8	4.0	3.5	3.2	2.8	2.5	1.9			
MF-RG500	7.3	6.6	6.0	5.0	4.4	4.0	3.6	3.1	2.4			
MF-RG600	8.8	8.0	7.2	6.0	5.2	4.8	4.2	3.8	2.8			
MF-RG650	9.5	8.6	7.8	6.5	5.7	5.2	4.6	4.1	3.0			
MF-RG700	10.3	9.3	8.4	7.0	6.2	5.6	5.0	4.4	3.3			
MF-RG800	11.7	10.7	9.6	8.0	6.9	6.4	5.6	5.1	3.7			
MF-RG900	13.2	11.9	10.7	9.0	7.9	7.2	6.4	5.6	4.2			
MF-RG1000	14.7	13.3	12.0	10.0	8.7	8.0	7.0	6.3	4.7			
MF-RG1100	16.1	14.6	13.1	11.0	9.7	8.8	7.8	6.9	5.2			

 $I_{trip}$  is approximately two times  $I_{hold}$ .

## Typical Time to Trip at 23 °C



## **Packaging Quantity**

Packaging options	Models	Unit Quantity (Pcs.)	Unit	
Bulk	All models	500	Bag	
Tono 9 Dool	MF-RG300 ~ MF-RG500	3000	Reel	
Tape & Reel	MF-RG600 ~ MF-RG1100	1000	neei	
Ammo-Pack	MF-RG300 ~ MF-RG500		Pack	
	MF-RG600 ~ MF-RG1100	1000	rack	

# **MF-RG Series Tape and Reel Specifications**

Devices taped using EIA-468/IEC 60286-2 standards. See table below and figures for details.

Dimension Description	IEC Mark	EIA Mark	Dimensions	Tolerance
Carrier tape width	W	W	18 (.709)	+1.0/-0.5 (+.039/020)
Hold down tape width	$W_0$	$W_0$	<u>5</u> (.197)	min.
Hold down tape		No p	rotrusion	
Adhesive tape position	W <sub>2</sub>	W <sub>2</sub>	<u>3</u> (.118)	max.
Sprocket hole position	$W_1$	W <sub>1</sub>	<u>9</u> (.354)	+0.75-0.5 (+.030/020)
Sprocket hole diameter	D <sub>0</sub>	D <sub>0</sub>	<u>4</u> (.157)	±0.2 (±.0078)
Height to seating plane (straight lead)	Н	Н	18 ~ 20 (.709 ~ .787)	
Height to seating plane (formed lead)	H <sub>0</sub>	H <sub>0</sub>	<u>16</u> (.630)	±0.5 (±.020)
Overall height above abscissa: MF-RG300 ~ MF-RG800	H <sub>1</sub>	H <sub>1</sub>	38.5 (1.516)	max.
Overall height above abscissa: MF-RG900 ~ MF-RG1100	H <sub>1</sub>	H <sub>1</sub>	43.5 (1.713)	max.
Cutout length		L	<u>11</u> (.433)	max.
Sprocket hole pitch	$P_0$	P <sub>0</sub>	<u>12.7</u> (.500)	±0.3 (±.012)
Device pitch: MF-RG300 ~ MF-RG500	P	Р	<u>12.7</u> (.500)	±0.3 (±.012)
Device pitch: MF-RG600 ~ MF-RG1100	P	Р	<u>25.4</u> (1.00)	±0.6 (±.024)
Pitch tolerance			20 consecutive	<u>±1</u> (±.039)
Composite tape thickness	t	t	<u>0.9</u> (.035)	max.
Overall tape and lead thickness	t <sub>1</sub>	t <sub>1</sub>	2.3 (.091)	max.
Splice sprocket hole alignment			0	±0.3 (±.012)
Front-to-back deviation	$\Delta_h$	$\Delta_h$	0	±1.0 (±.039)
Side-to-side deviation	$\Delta_p$	$\Delta_p$	0	±1.3 (±.051)
Ordinate to adjacent component lead	P <sub>1</sub>	P <sub>1</sub>	3.81 (.150)	±0.7 (±.028)
Lead spacing	F	F	5.08 (.200)	+0.6/-0.2 (+.024/008)

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DIMENSIONS: (INCHES)

# **MF-RG Series Tape and Reel Specifications**

MM

(INCHES)

DIMENSIONS:

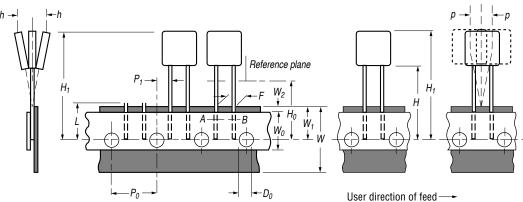
Dimension Description	IEC Mark	EIA Mark	Dimensions	Tolerance
Reel width including flanges and hub	$W_4$	w <sub>2</sub>	<u>62.0</u> (2.44)	max
Dimension between flanges (measured at hub)	W <sub>3</sub>	w <sub>1</sub>	allow proper reeling	and unreeling
Reel diameter	А	а	370.0 (14.57)	max.
Space between flanges (at hub, excluding device)			<u>4.75</u> (.187)	±3.25 (±.128)
Arbor hole diameter	С	С	<u>26.0</u> (1.024)	±12.0 (±.472)
Core diameter	N	п	<u>80</u> (3.15)	min.
Box dimensions			62 x 372 x 372 (2.44 x 14.6 x 14.6)	max.
Consecutive missing places			3	max.

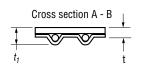
Less than 0.1 % Empty places per reel



**Applies to Models:** 

MF-RG300 ~ MF-RG1100

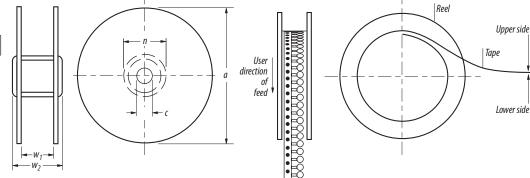




#### Reel Dimensions - per EIA Mark -Figure 2

## Applies to Models:

MF-RG300 ~ MF-RG1100



MF-RG SERIES, REV. Q, 03/22

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## **Bourns® Multifuse® PPTC Resettable Fuses**

**BOURNS** 

## **Application Notice**

- Users are responsible for independent and adequate evaluation of Bourns® Multifuse® Polymer PTC devices in the user's
  application, including the PPTC device characteristics stated in the applicable data sheet.
- Polymer PTC devices must not be allowed to operate beyond their stated maximum ratings. Operation in excess of such
  maximum ratings could result in damage to the PTC device and possibly lead to electrical arcing and/or fire. Circuits with
  inductance may generate a voltage above the rated voltage of the polymer PTC device and should be thoroughly evaluated
  within the user's application during the PTC selection and qualification process.
- Polymer PTC devices are intended to protect against adverse effects of temporary overcurrent or overtemperature
  conditions up to rated limits and are not intended to serve as protective devices where overcurrent or overvoltage conditions
  are expected to be repetitive or prolonged.
- In normal operation, polymer PTC devices experience thermal expansion under fault conditions. Thus, a polymer PTC
  device must be protected against mechanical stress, and must be given adequate clearance within the user's application to
  accommodate such thermal expansion. Rigid potting materials or fixed housings or coverings that do not provide adequate
  clearance should be thoroughly examined and tested by the user, as they may result in the malfunction of polymer PTC
  devices if the thermal expansion is inhibited.
- Exposure to lubricants, silicon-based oils, solvents, gels, electrolytes, acids, and other related or similar materials may adversely affect the performance of polymer PTC devices.
- Aggressive solvents may adversely affect the performance of polymer PTC devices. Conformal coating, encapsulating, potting, molding, and sealing materials may contain aggressive solvents including but not limited to xylene and toluene, which are known to cause adverse effects on the performance of polymer PTCs. Such aggressive solvents must be thoroughly cured or baked to ensure their complete removal from polymer PTCs to minimize the possible adverse effect on the device.
- Recommended storage conditions should be followed at all times. Such conditions can be found on the applicable data sheet and on the Multifuse® Polymer PTC Moisture/Reflow Sensitivity Classification (MSL) note: <a href="https://www.bourns.com/docs/RoHS-MSL/msl">https://www.bourns.com/docs/RoHS-MSL/msl</a> mf.pdf